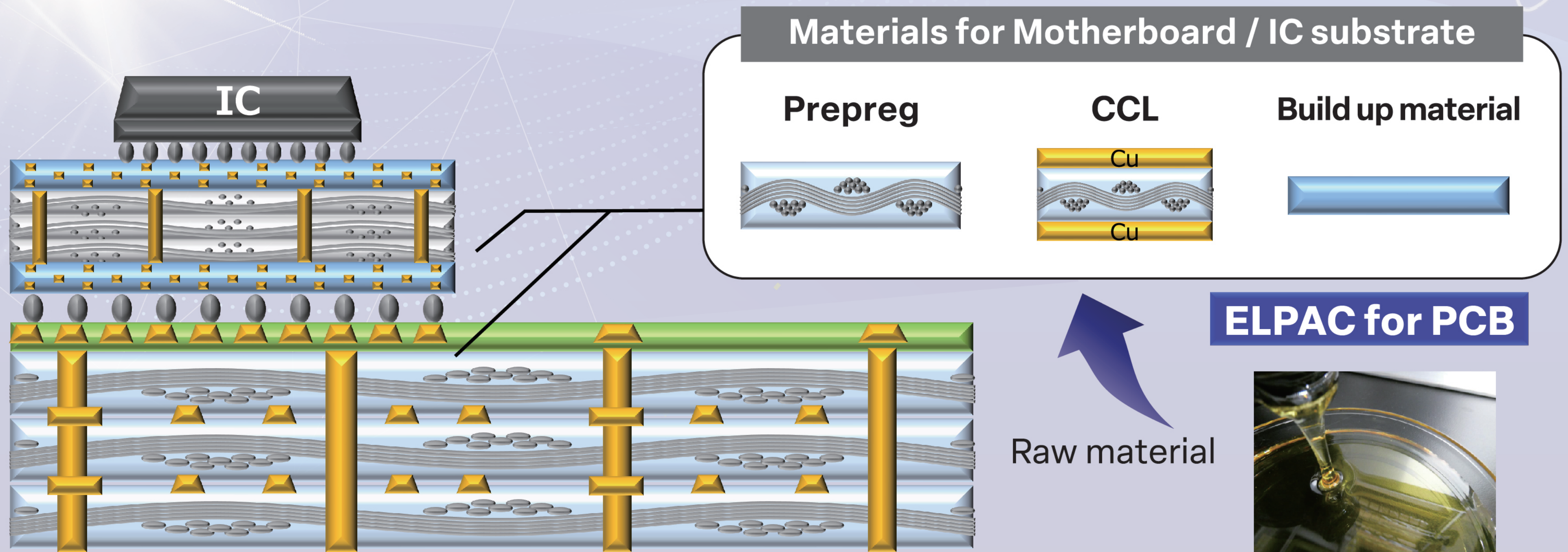


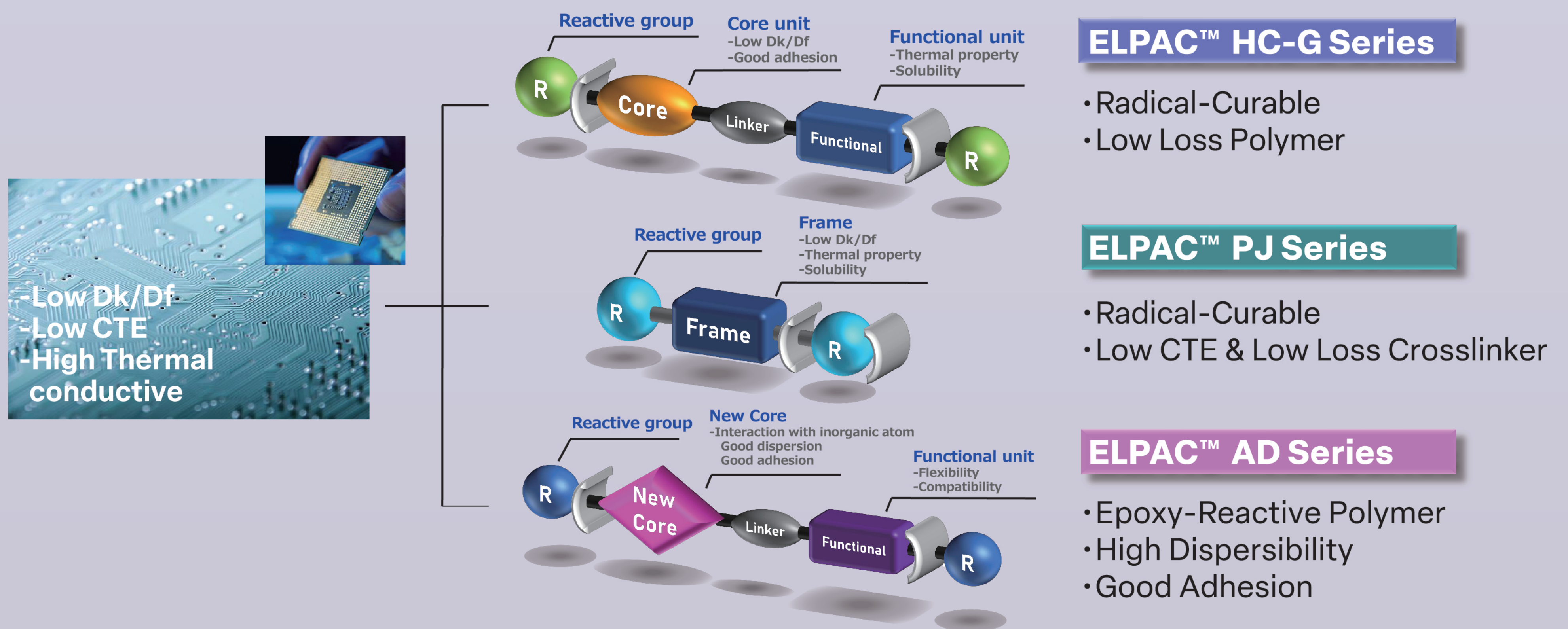
JSR ELPAC™

HC-G / PJ / AD series for PCB

Application



Line-up



Properties based on evaluation example

Sample		HC-G	HC-G + PJ
Composition	Polymer	HC-G	HC-G
	Crosslinker	w/o	PJ *1
	Initiator	w/	w/
Properties	Dk @10GHz	2.6	2.6
	Df @10GHz	0.001	0.001
	Total CTE (40-260°C)	Ref.	35% down

*1: 30%

Sample		Ref.	AD
Composition	Filler	BN/SiO ₂	BN/SiO ₂
	Additive	w/o	AD *2
Properties	Viscosity	Ref.	90% down
	Appearance		

*2: 7%